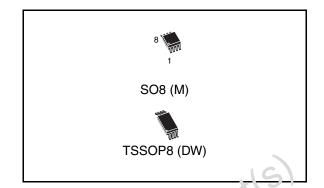


# STHS2375A, STHS2375L, STHS2376A, STHS2376L, STHS2377A, STHS2377L

### IEEE 802.3af PoE Powered Device (PD) interface controller

### **Features**

- IEEE 802.3af-compliant interface for Powered Devices (PDs)
- Integrated 100V, 500mA power MOSFET
- Resistor-programmable inrush current limit
- Normal operation current limit 460mA
- External 25kΩ signature resistor
- Resistor-programmable classification current (Class 0-4)
- Power Good output (active-high), open drain
- Undervoltage Lockout (UVLO) standard, programmable, and legacy (see *Table 1*)
- Thermal overload protection
- Latch (L) or auto-retry (A) after hard current overload or repetitive thermal overload
- Industrial temperature range: -40 to +85°C
- 8-pin SO and 8-pin TSSOP packages
- RoHS compliant



### **Applications**

- Voice over IP (VOIP) phones
- Web cameras
- WLAN access points
- Internet appliances
- FOS terminals
- PRFID readers

### Table 1. Device options

Order code	External signa:ure resistor (1%)	UVLO	UVLO threshold, rising (V)	UVLO threshold, falling (V)	Protection mode
STHS2375A	24.9kΩ	Standard	39.3	30.5	Auto
STHS2375L	24.9kΩ	Standard	39.3	30.5	Latch
STHS2376 A.	24.9kΩ	Programmable	2.49	1.93	Auto
ST/iS2376L	24.9kΩ	Programmable	2.49	1.93	Latch
S <sup>7</sup> HS2377A	24.9kΩ	Legacy	35.1	30.5	Auto
STHS2377L	24.9kΩ	Legacy	35.1	30.5	Latch

July 2007 Rev 4 1/20

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### 1 Summary description

The STHS237x is an IEEE802.3af-compliant family of interface controllers for Power over Ethernet (PoE) Powered Device (PD) applications. The devices consist of two main sections:

- The IEEE802.3af interface to the PoE powered RJ-45 wall socket, and
- the Hot Swap Controller (HSC) functions required to protect the PD during insertion, operation, and withdrawal from the RJ-45 socket.

These devices have an integrated high voltage power MOSFET (low-side switch) with low  $R_{DS\ ON}$  and the capability to accept transients as high as 100V. Since the pins (such as  $V_{DD}$  and  $V_{SS}$ ) which interface to the RJ-45 socket can routinely see high peak voltages in excess of 100V, it is strongly recommended that board designers protect the PD device with a transient voltage suppressor, such as the SMAJ58A (available from STMicroelectronics), connected between the  $V_{DD}$  and  $V_{SS}$  pins (see *Figure 4 on page 8*).

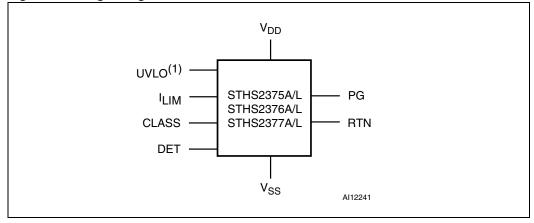
The IEEE802.3af-compliant interface includes the basic PD Detection and Classification functions, whereas the 'Hot Swap' functions include other basic features, such as Inrush Current Limiting, Undervoltage Lockout (UVLO), and Thermal Overload Protection. All of the devices include an open drain Power Good (PG) signal to indicate normal steady operation (see *Figure 1 on page 6* and *Table 2 on page 6*). The STHS237x family also incorporates a voltage offset (two series diodes) to accommodate the input diode bridge used to make the PD polarity insensitive.

The STHS237x family comprises devices for all the UVLO limits configurations: IEEE standard compliant (STHS2375), programmable (STHS2376) and for legacy systems (STHS2377). See *Table 1 on page 1*.

Each of the basic part types, the STHS2375, STHS2376 and the STHS2377, is available either with Latched Operation (L) Mode or with Automatic Retry (A) Mode after fault conditions. For product options overview see *Table 1 on page 1*.



Figure 1. Logic diagram



1. STHS2376A/L devices only.

Table 2. Signal names

	Oigilai ilai	
Pin	Symbol	Description
1	I <sub>LIM</sub>	Inrush Current Limit resistor
2	CLASS	Classification resistor
3	DET	Powered Device Detection resistor
4	V <sub>SS</sub>	Ground on the input side; return power line to PSE
5	RTN	Return power output, negative rail
6	PG	Power Good Output, open drain, active-high (referenced to RTN)
7	UVLO (1)	Programmable Undervoltage Lockout input pin
8	V <sub>DD</sub>	Positive Power Supply; common input/output power rail

<sup>1.</sup> STHS2376A/L devices only, for other part types No Connect.

Figure 2. STHS2375A/L, STHS2377A/L pin connections (top view)

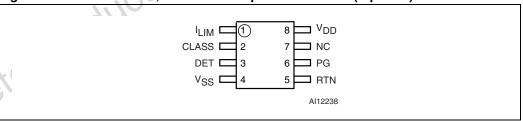
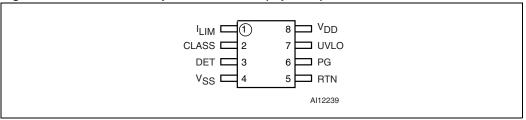


Figure 3. STHS2376A/L pin connections (top view)



#### 1.1 Pin descriptions

#### 1.1.1 Current limit (I<sub>LIM</sub>)

Connect a resistor between I<sub>LIM</sub> and V<sub>SS</sub> to set the start-up inrush current limit.  $I_{LIM}$  = 25 000/ $R_{ILIM}$  [A]. Practical values of  $R_{ILIM}$  are between 62.5k $\Omega$  and 500k $\Omega$ .  $R_{II\,IM} = 178k\Omega$  for inrush current of 140mA for compatibility with legacy PSEs. Do not leave open or connect to V<sub>SS</sub>.

#### 1.1.2 Classification (CLASS)

Connect a Classification resistor between this pin and  $V_{SS}$  to tell the PSE which power class will be connected. Do not connect this pin directly to V<sub>SS</sub>.

For classification resistor values, see Table 3 on page 8.

#### 1.1.3 **Detection resistor (DET)**

Connect a 24.9k $\Omega$  resistor between DET and V<sub>DD</sub> to allow the PSE to detect the Powered Product Device properly.

#### 1.1.4 Ground (V<sub>SS</sub>)

This is the return power line on the PSE side (negative).

#### 1.1.5 Return (RTN)

This is the return power output on the load side, negative rail.

#### 1.1.6 Power Good output (PG)

This pin indicates that the STHS power MOSFET is fully on and works in normal operation mode (Power Good). Open drain, high impedance means that the power is good; in all other cases, the impedance is low (referenced to RTN).

#### 1.1.7 Undervoltage Lockout Input (UVLO, STHS2376A/L only)

Connect the tap of the resistor divider between  $V_{DD}$  and  $V_{SS}$  to set the UVLO voltage limits (see Figure 6 on page 10).

Note: STHS2376A/L only, for all other devices, this is No Connect.

### Power supply (V<sub>DD</sub>)

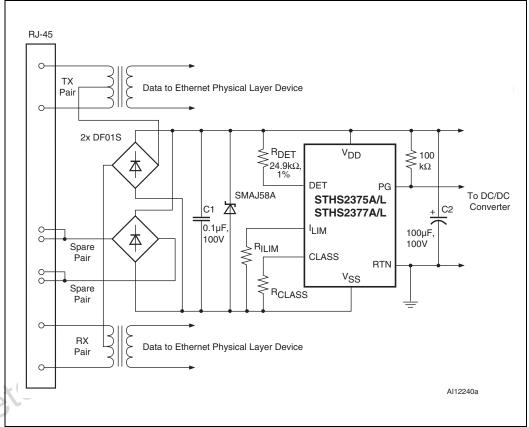
This is the Power Input/Output, positive rail.

Table 3.	IEEE802.3af	PD power classes and	l corresponding R <sub>CLA</sub>	<sub>iSS</sub> values
				1

Class	Usage	Max. Power at Input of PD (W)	Classification Load Current Limits (mA)	R <sub>CLASS</sub> Resistor (Ω, 1%)
0	Default	0.44 to 12.95	0-4	4420
1	Optional	0.44 to 3.84	9-12	953
2	Optional	3.84 to 6.49	17-20	549
3	Optional	6.49 to 12.95	26-30	357
4	Reserved	Reserved <sup>(1)</sup>	36-44	255

<sup>1.</sup> Class 4 is currently reserved and should not be used.

Figure 4. Application circuit overview (STHS2375A/L, STHS2377A/L)



Note: This configuration uses either data wires or spare wires for DC power.

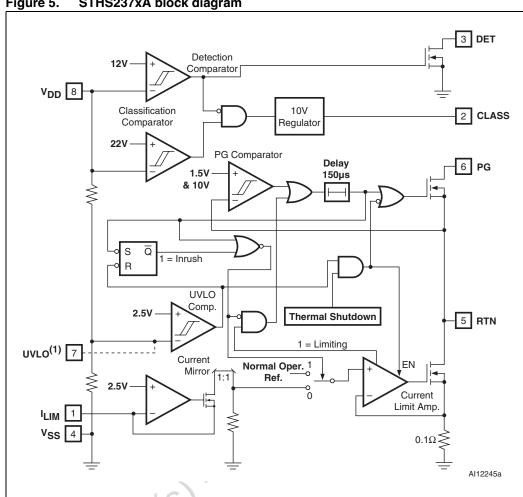


Figure 5. STHS237xA block diagram

STHS2376A/L devices only. The UVLO comparator is connected directly to the UVLO input pin instead of the internal UVLO divider. For all other devices, pin 7 is NC (No Connect). Obsolete Prol

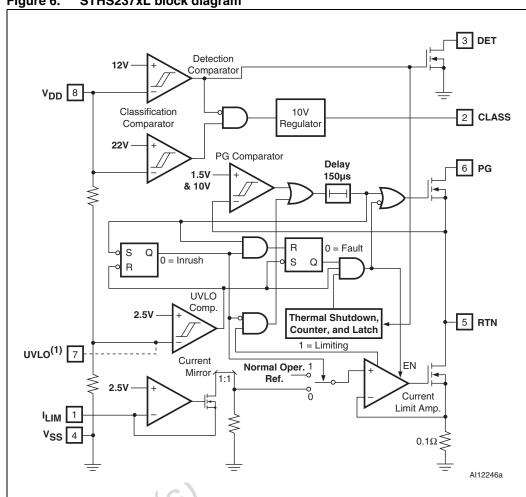


Figure 6. STHS237xL block diagram

 STHS2376A/L devices only. The UVLO comparator is connected directly to the UVLO input pin instead of the internal UVLO divider. For all other devices, pin 7 is NC (No Connect). Obsolete Prof

### 2 Absolute maximum ratings STHS237xA, STHS237xL

Stressing the device above the rating listed in *Table 4: Absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Over the full operating temperature range, unless otherwise noted. Voltages are referenced to the  $V_{SS}$  pin.

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
Voltage			
V <sub>VDD</sub> , V <sub>RTN</sub>		-0.3 to 100	V
V <sub>DET</sub> , V <sub>PG</sub> <sup>(1)</sup>		-0.3 to 90	V
V <sub>UVLO</sub>	Voltage on the respective pins, referenced to V <sub>SS</sub> pin	-0.3 to10	V
V <sub>ILIM</sub> (2)	to v <sub>SS</sub> pin	-0.3 to 3	V
V <sub>CLASS</sub> (2)		-0.3 to 12	V
Current, sinking			
I <sub>RTN</sub>	16:16	0 to 515	mA
I <sub>PG</sub>	Current sunk by the respective pins	0 to 10	mA
I <sub>DET</sub>	0/05	0 to 1	mA
Current, sourcing	O		
I <sub>CLASS</sub>	Current sourced by the respective pins	0 to 100	mA
I <sub>ILIM</sub>	Current sourced by the respective pins	0 to 1	mA
ESD			
V <sub>HBM</sub>	ESD Capability, Human body model	2	kV
V <sub>CDM</sub>	ESD Capability, Charged device model	500	V
Temperature			
T <sub>A</sub>	Operating ambient temperature range	-40 to 85	°C
T <sub>J</sub>	Maximum junction temperature	Internally limited	°C
T <sub>STG</sub>	Storage temperature	-55 to 150	°C
T <sub>SLD</sub>	Lead solder temperature for 10 seconds, lead-free lead finish (3)	260	°C

- 1.  $I_{RTN} = 0$
- 2. Voltage output, do not apply external voltage to the CLASS and  $I_{LIM}$  pins.
- 3. Reflow at peak temperature of 260°C (total thermal budget not to exceed 245°C for more than 30 seconds).



#### 3 Electrical parameters STHS237xA, STHS237xL

Specifications common for all the STHS237xA/L product family unless otherwise noted.

 $V_{DD}=48 \text{V}, \ R_{DET}=24.9 \text{k}\Omega, \ R_{CLASS}=255\Omega, \ R_{ILIM}=178 \text{k}\Omega, \ T_{J}=-40 \ \text{to} \ 125^{\circ}\text{C}, \ \text{unless otherwise noted, typical values at } 25^{\circ}\text{C}. \ \text{For the STHS2376x} \ V_{UVLO}=0 \text{V for classification}$ and  $V_{UVLO} = 5V$  otherwise. Voltages are referenced to the  $V_{SS}$  pin unless otherwise noted. Positive currents are into pins.

Table 5. **Electrical parameters** 

Table 5. Electrical parameters								
Symbol	Parameter	Test conditions	Min	Тур	Max	Units		
Recommended operating conditions								
	Input voltage range	V <sub>DD</sub> , PG, RTN	0		57	V		
		UVLO	0		5	Cy		
I <sub>RTN</sub>	Operating current range (sinking)	RTN	0	~6	450	mA		
R <sub>CLASS</sub>	Classification resistor <sup>(1)</sup> , <sup>(2)</sup>	CLASS	255	) )	4420	Ω		
R <sub>ILIM</sub>	Inrush current limit programming resistor (2)	coleite	62.5		500	kΩ		
I <sub>PG(SINK)</sub>	Sinking current	PG = low	0		10	mA		
Тл	Operating junction temperature	, 0 '	-40		125	°C		
T <sub>A</sub>	Operating free-air temperature		-40		85	°C		

Lested with exact resistor values. A 1% tolender compliance with IEEE 802.3af classification current lime.

2. Do not apply external voltage to the CLASS and I<sub>LIM</sub> pins. Classification tested with exact resistor values. A 1% tolerance of classification resistor values is sufficient for compliance with IEEE 802.3af classification current limits.

Table 6. DC characteristics

Table 6.	DC characteristics						
Symbol	Parameter	Test condition	s	Min	Тур	Max	Unit
Detection	•						
	Offset current	DET open, $V_{VDD} = V_{RTN} = 1.9V$ , measure $I_{VDD} + I_{RTN}$			0.3	3	μA
	Sleep current	DET open, V <sub>VDD</sub> = V <sub>RTN</sub> = 10.1V, measure I <sub>VDD</sub> + I <sub>RTN</sub>			4	12	μA
I <sub>IL(DET)</sub>	DET pin leakage current	$V_{DET} = V_{VDD} = 57V$ , measure	I <sub>DET</sub>		0.1	5	μΑ
I <sub>DET</sub>	Detection current	$V_{RTN} = V_{VDD}$ , $R_{DET} = 24.9k\Omega$ , $V_{VDD} = 1.4V$		53.7	56	58.3	μΑ
ישני	measure $I_{VDD} + I_{RTN} + I_{DET}$ $V_{VDD} = 10.1V$		395	410	417	μΑ	
Classificatio	on						
		$R_{CLASS} = 4420\Omega$ , $V_{VDD} = 13$ to	21V	2.2	2.4	2.8	mA
		$R_{CLASS} = 953\Omega$ , $V_{VDD} = 13$ to	21V	10.3	10.6	11.3	mA
I <sub>CLASS</sub>	Classification current <sup>(1)</sup>	$R_{CLASS} = 549\Omega$ , $V_{VDD} = 13$ to	21V	17.7	18.3	19.5	mA
		$R_{CLASS} = 357\Omega$ , $V_{VDD} = 13$ to 21V			28.0	29.5	mA
		$R_{CLASS} = 255\Omega$ , $V_{VDD} = 13$ to	$R_{CLASS} = 255\Omega$ , $V_{VDD} = 13$ to 21V			41.2	mA
V <sub>CL(ON)</sub>	Classification lower threshold	Regulator turns on, V <sub>VDD</sub> rising			11.3	13.0	٧
V <sub>CU(OFF)</sub>	Classification upper threshold	Regulator turns off, V <sub>VDD</sub> rising			21.9	23	٧
V <sub>CU(H)</sub>		Hysteresis			0.78	1	٧
I <sub>IL(CLASS)</sub>	CLASS pin leakage current	V <sub>CLASS</sub> = 0V, V <sub>VDD</sub> = 57V				1	μA
Pass device		.(5)					
R <sub>DS(ON)</sub>	On resistance	I <sub>RTN</sub> = 300mA			0.72	1.0	Ω
I <sub>RTN(L)</sub>	RTN pin leakage current	$V_{VDD} = V_{RTN} = 30V (V_{UVLO} = STHS2376x)$	0V for			15	μΑ
I <sub>LIM(N)</sub>	Normal operation current limit	V <sub>RTN</sub> = 1V		405	461	515	mA
I <sub>LIM(I)</sub>	Inrush mode current limit	$V_{RTN} = 2V$ , $R_{ILIM} = 178k\Omega$		100	130	180	mA
O <sub>2</sub>	Inrush current termination <sup>(2)</sup>	$V_{RTN}$ falling, $R_{ILIM} = 178 k\Omega$ , in normal operation mode	rush mode to	85	91	100	%
	Current rise time to inrush <sup>(3)</sup>	$R_{ILIM} = 69.8 k\Omega$ , $V_{RTN-VSS} = 5V_{RTN-VSS} = 5V_{RTN-VSS}$		15	34		μs
I <sub>IL(ILIM)</sub>	ILIM pin leakage current	V <sub>VDD</sub> = 15V, V <sub>UVLO</sub> = 0V				1	μΑ
Power Good	(PG)						
V <sub>RTN(LO R)</sub>	RTN latch off voltage, rising <sup>(4)</sup>	V <sub>RTN</sub> rising		9.5	10.0	10.5	٧
				•			



Table 6. DC characteristics (continued)

Symbol	Parameter	Test conditions		Тур	Max	Unit
	PG deglitch	Delay rising and falling PG	75	150	225	μs
V	Output low voltage	$I_{PG} = 2mA$ , $V_{RTN} = 34V$ , $V_{VDD} = 38V$ , $V_{RTN}$ falling		0.12	0.4	٧
V <sub>PG(OL)</sub>	Output low voltage	$I_{PG}$ = 2mA, $V_{RTN}$ = 0V, $V_{VDD}$ = 25V, for STHS2376x $V_{UVLO}$ = 0V		0.12	0.4	٧
I <sub>OL(PG)</sub>	PG pin leakage current	$V_{VDD} = V_{PG} = 57V, V_{RTN} = 0V$		0.1	1	μΑ
Undervoltage	lockout (UVLO)					
V <sub>UVLO(R)</sub>		Voltage at V <sub>DD</sub> pin, V <sub>VDD</sub> rising	38.4	39.3	40.4	٧
V <sub>UVLO(F)</sub>	UVLO Thresholds, STHS2375x	Voltage at V <sub>DD</sub> pin, V <sub>VDD</sub> falling	29.6	30.5	31.5	٧
V <sub>UVLO(H)</sub>	0 0 <u>-</u> 0	Hysteresis	8.3	8.8	9.1	٧
V <sub>UVL(R)</sub>		Voltage at UVLO pin, V <sub>UVLO</sub> rising	2.43	2.49	2.57	٧
V <sub>UVLO(F)</sub>	UVLO Thresholds, STHS2376x	Voltage at UVLO pin, V <sub>UVLO</sub> falling	1.87	1.93	1.98	٧
V <sub>UVLO(H)</sub>		Hysteresis	0.53	0.56	0.58	٧
V <sub>UVLO(R)</sub>		Voltage at V <sub>DD</sub> pin, V <sub>VDD</sub> rising	34.1	35.1	36.0	٧
V <sub>UVLO(F)</sub>	UVLO Thresholds, STHS2377x	Voltage at V <sub>DD</sub> pin, V <sub>VDD</sub> falling	29.7	30.5	31.4	٧
$V_{\text{UVLO(H)}}$		Hysteresis	4.3	4.5	4.8	٧
I <sub>IL(UVLO)</sub>	UVLO pin leakage current (STHS2376x only)	V <sub>UVLO</sub> = 0 to 5V	-1		1	μA
Thermal shut	down	00				
T <sub>SHUTDOWN</sub>	Shutdown temperature <sup>(3)</sup> , temperature rising	(5)		140		°C
T <sub>SHUTDOWN H</sub>	Hysteresis <sup>(3)</sup>			20		°C
Supply currer	nt 0100					
I <sub>DD</sub>	Operating current			250	450	μΑ

Classification tested with exact resistor values. A 1% tolerance of classification resistor values is sufficient for compliance with IEEE 802.3af classification current limits.

<sup>2.</sup> Percentage of the intial steady state RTN inrush current value, below which inrush is terminated and PG goes active.

<sup>3.</sup> Not tested in production.

<sup>4.</sup> Gradually increase  $V_{RTN}$  from 0V until  $I_{RTN}$  disappears.

### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Obsolete Product(s). Obsolete Product(s)

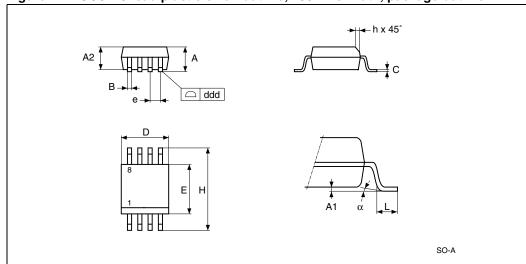
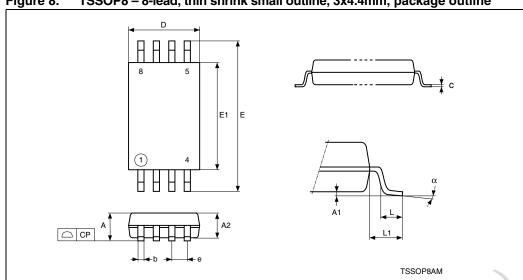


Figure 7. SO8 – 8-lead plastic small outline, 150 mils width, package outline

Note: Drawing is not to scale.

Table 7. SO8 – 8-lead plastic small outline, 150 mils width, package mechanical data

	uala							
	Sumb		mm		0			
	Symb	Тур	Min	Max	Тур	Min	Max	
	А	_	1.35	1.75	0 -	0.053	0.069	
	A1	_	0.10	0.25	_	0.004	0.010	
	В	-	0.33	0.51	_	0.013	0.020	
	С	_	0.19	0.25	_	0.007	0.010	
	D	- %	4.80	5.00	_	0.189	0.197	
	ddd	' -/C)	-	0.10	_	-	0.004	
	E	$2O_{7}$	3.80	4.00	_	0.150	0.157	
	е	1.27	-	-	0.050	-	_	
	Н	-	5.80	6.20	_	0.228	0.244	
10	h	-	0.25	0.50	_	0.010	0.020	
anson	L		0.40	0.90		0.016	0.035	
002	α		0°	8°	_	0°	8°	
O'	N		8	-		8	_	



TSSOP8 - 8-lead, thin shrink small outline, 3x4.4mm, package outline Figure 8.

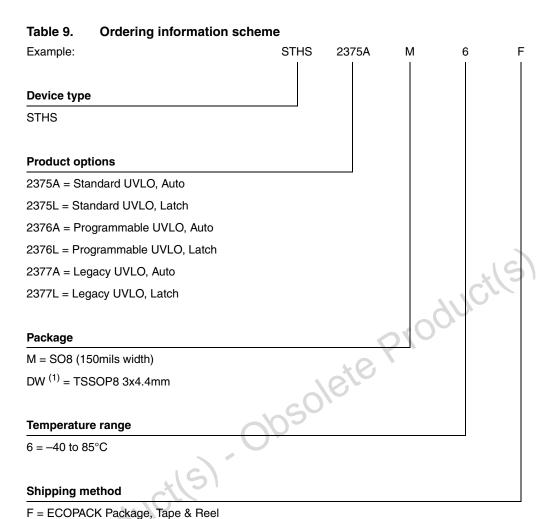
Note: Drawing is not to scale.

Table 8. TSSOP8 - 8-lead, thin shrink small outline, 3x4.4mm, package mechanical data

Symb	mm			inches		
	Тур	Min	Max	Тур	Min	Max
Α			1.200			0.0472
A1		0.050	0.150		0.0020	0.0059
A2	1.000	0.800	1.050	0.0394	0.0315	0.0413
b		0.190	0.300		0.0075	0.0118
С	1.10	0.090	0.200		0.0035	0.0079
СР	000		0.100			0.0039
D	3.000	2.900	3.100	0.1181	0.1142	0.1220
е	0.650	-	-	0.0256	_	_
E	6.400	6.200	6.600	0.2520	0.2441	0.2598
E1	4.400	4.300	4.500	0.1732	0.1693	0.1772
L	0.600	0.450	0.750	0.0236	0.0177	0.0295
L1	1.000			0.0394		
α		0	8		0	8
N	8			8		

Part numbering STHS237x

### 5 Part numbering



<sup>1.</sup> Contact local ST sales office for availability.

E = ECOPACK Package, Tube

For other options, or for more information on any aspect of this device, please contact the ST Sales Office nearest you.

STHS237x Revision history

## 6 Revision history

Table 10. Document revision history

Date Revision		Changes		
11-Aug-2006	1	Initial release.		
19-Dec-2006	2	Updated Features and Table 4.		
24-May-2007	3	Formatting changes, updated <i>Table 1, 4, 5, 6</i> .		
26-Jul-2007	4	Document status upgraded to full datasheet, updated cover page and <i>Table 9</i> .		



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